STANDARD SEALED 3U ATR ENCLOSURE Dry air contaminant-free compact SWaP applications » Low cost & weight 5 slot 3U single version » CM's 3U Entry level, natural air convection solution » Supports conduction & air-cooled 1" pitch modules » Up to 80 watts chassis power dissipation* » Designed for very low wattage demands » Internal forced-air recirculation » Silent, no external fans » 1"5 TO. AUAL ATT I 201 0 0 0 FUN TSH PWF TSLO CM Computer TSDI 0 0 COMS LINK 0 6

TEST

1

GND

0

0

POWER

0

7



Sealed 3U ATR - Contaminant-free Enclosure suitable for low wattage VME, VPX & cPCI applications with 0.8, 0.85 & 1" pitch 3U eurocards

Our 3U *Standard Sealed* chassis is the most compact SWaP passive cooling enclosure within the CM product range. Designed specifically for small aerospace and UAV applications that require state-of-the-art technology at low cost, this model is ideal for low power 3U military systems that must be protected against hostile or harmful air contaminants.

AVAILABILITY

The 3U CM Sealed ATR is available in a 5 slot, 1" pitch version only. This chassis incorporates our 3U military VME, cPCI, or VPX backplanes and CM's most integrated Power Supply Unit (from 450 to 825 watts).

CHASSIS COOLING & COLD PLATE MOUNTING

The CM-ATR-3U/S chassis can be optionally cold plate mounted to increase its natural convection power dissipation rates by approximately 20%. Dry air internal recirculation fans ensure homogeneous electronic module hot-spot cooling.

CM-ATR-3U/S Specifications

DIMENSIONS	W 153 mm H 225 mm D 248 mm	SLOTS	5		
WEIGHT	3.9 Kg	FRONT PANEL AREA	125 mm x 140 mm		
CGTR THERMAL RES.	$\Delta T/W = 0.32$ °C	CM FRONT PANEL	6 Power Pins (13 Amp) & 382 I/O Pins (5 Amp)		
INTERNAL FAN	54 CFM	TEMPERATURE SPEC	-40°C to 85°C Op., -55°C to 100°C Stg.		
MAX. PSU MODEL	C-825W	MTBF	25° GB 82,000 Hours, 65° AIC 27,000 Hours		
PSU POWER	450 to 825 watts	MOUNTING TRAY	CM-TR-3U/S		
STD BACKPLANE	VME64X or cPCI or VPX 5 slot 1" pitch 3U backplanes				
PSU V-INPUT	28 VDC ±30%, 48 VDC ±30%, 72 VDC ±30%, 270 VDC ±30%, Autorange 90-132 VAC RMS & 180-264 VAC RMS @ 47-880 Hz, 3-Phase 200 VAC @ 47-880 Hz ±30%				
SLOT/BOARD FORMAT	CCS: Conduction-cooled slots only or MCS: Slot-by-slot user configured card-cage allows intermixing conduction-cooled ANSI-VITA 48.2 & air-cooled ANSI-VITA 48.1 boards				

COMPLEMENTARY INFORMATION

• CM ATR Common Features

CM ATR Backplanes • CM ATR Power Supplies

PART NUMBER EXAMPLE:

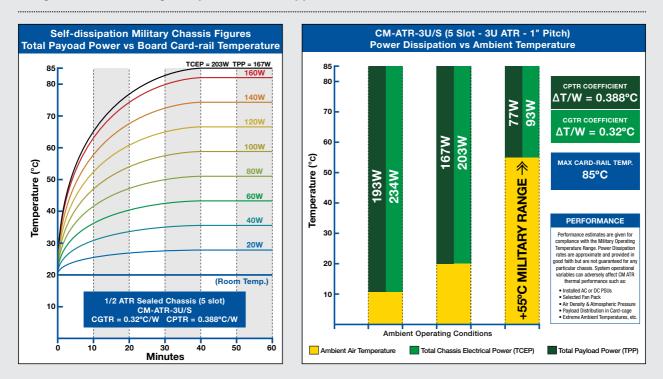
CM-ATR-3U/S/VPX/90-264VAC/C-575W/UDP/STC/SBC/MCS/B For ordering information see page 127 of this catalog.





3U s Military ATR Chassis Performance

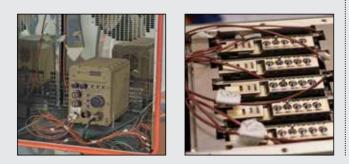
designed for low wattage, 1" pitch - sealed applications

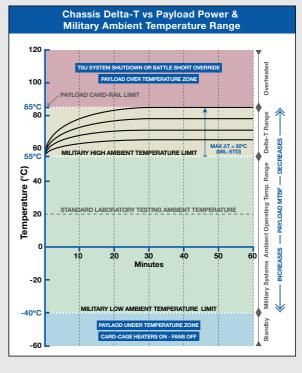


MAXIMUM MILITARY SYSTEM DELTA-T

Maximum conduction-cooled payload card-rail temperature is typically 85°C. To comply with MIL-STD-810, systems must be operational up to 55°C ambient (worst case scenario).

In theory, this restricts payload maximum ΔT to 85°C - 55°C ($\Delta Tmax = 30$ °C). Temperatures in excess of 85°C dramatically increase the risk of module failure and reduce component MTBF. Military limits may be relaxed for systems serving in 'indoor environments' (e.g. to 40°C ambient). Under these conditions ΔT margin can be increased to 85°C - 40°C = 45°C $\Delta Tmax$.







3U Military ATR Chassis Ordering



SWaP military aerospace enclosure part number configuration

Please carefully follow our chassis ordering guide for configuring your 3U ATR part number. Note that all CM 3U Backplanes integrate a functional Temperature Supervisory Unit (TSU) that controls Power Supply and Fan operation. Remote optoisolated control switches for 'Battle-short' and chassis PSU 'on/standby' are also fitted as standard.

CHASSIS GENERIC PART NUMBER:

CM-ATR-3U /CT /B /I /W /FP /TC /BC /CS /F /C

/CT Enclosure Cooling Technique

S: Standard Sealed 3U Enclosure *SEF-18HP*: Sealed with Extended Fins + 18 Heat Pipes 3U Enclosure *HES*: Sealed with Heat Exchangers 3U Enclosure *HES-FBL(3-5-7-9)*: Sealed with Heat Exchangers 3U Enclosure *HES-FBL(3-5-7-9)-HP*: Sealed with Heat Exchangers + Heat Pipes 3U Enclosure *FAC*: Flowthrough Air Cooled 3U Enclosure (open, non-sealed)

/B Backplane Type

VME64x: Military VME64x Backplane (5 Slot 3U 1" Pitch)
cPCI-S: Military Compact PCI Serial R.2.0 Backplane (3-5-7-9 Slot 3U 1" Pitch)
VPX: VITA 46 Military VPX Backplane (3-5-7-9 Slot 3U 1" Pitch)
VPX-6: VITA 46 Military VPX Backplane (6 Slot 3U 0.85" Pitch)

/I PSU Input Power Voltage

28VDC: 28 VDC Input 48VDC: 48 VDC Input 72VDC: 72 VDC Input 270VDC: 270 VDC Input 90-264VAC: Autorange 90-264 VAC @ 47-880 Hz Input 200VAC-3Ph: 200 VAC 3 Phase @ 47-880 Hz Input

/W Power Supply Unit Watts

A-475W: 28 VDC (+5 VDC @ 40A, +3.3 VDC @ 22A, ±12 VDC @ 8A) **A-575W:** All PSUs (+5 VDC @ 40A, +3.3 VDC @ 22A, ±12 VDC @ 12A) **A-675W:** 28 VDC (+5 VDC @ 80A, +3.3 VDC @ 22A, ±12 VDC @ 8A)⁺ **A-775W:** All PSUs (+5 VDC @ 80A, +3.3 VDC @ 22A, ±12 VDC @ 12A)⁺

B-450W: 28 VDC (+5 VDC @ 20A, +3.3 VDC @ 45A, ±12 VDC @ 8A) **B-550W:** All PS Us (+5 VDC @ 20A, +3.3 VDC @ 45A, ±12 VDC @ 12A) **B-564W:** 28 VDC (+5 VDC @ 20A, +3.3 VDC @ 80A, ±12 VDC @ 8A)* **B-664W:** All PSUs (+5 VDC @ 20A, +3.3 VDC @ 80A, ±12 VDC @ 12A)*

C-475*W*: 28 VDC (+5 VDC @ 20A, +3.3 VDC @ 22A, +12 VDC @ 16A,-12 VDC @ 8A) *C*-575*W*: All PSUs (+5 VDC @ 20A, +3.3 VDC @ 22A, +12 VDC @ 21A, -12 VDC @ 12A) *C*-775*W*: 28 VDC (+5 VDC @ 20A, +3.3 VDC @ 22A, +12 VDC @ 41A, -12 VDC @ 8A)[▲] *C*-825*W*: All PSUs (+5 VDC @ 20A, +3.3 VDC @ 22A, +12 VDC @ 41A, -12 VDC @ 12A)[▲]

D-550W: 28 VDC (+5 VDC @ 40A, +3.3 VDC @ 45A, ±12 VDC @ 8A)* *D-650W*: All PSUs (+5 VDC @ 40A, +3.3 VDC @ 45A, ±12 VDC @ 12A)*

E-550W: 28 VDC (+5 VDC @ 20A, +3.3 VDC @ 45A, +12 VDC @ 16A, -12 VDC @ 8A)* *E-650W*: All PSUs (+5 VDC @ 20A, +3.3 VDC @ 45A, +12 VDC @ 21A, -12 VDC @ 12A)*

F-575W: 28 VDC (+5 VDC @ 40A, +3.3 VDC @ 22A, +12 VDC @ 16A,-12 VDC @ 8A)^A *F-675W*: All PSUs (+5 VDC @ 40A, +3.3 VDC @ 22A, +12 VDC @ 21A, -12 VDC @ 12A)^A

All PSUs = All PSUs except 28 VDC input | 28 VDC = 28 VDC input only *PSU not available for CM-ATR-3U/FAC & CM-ATR-3U/HES-FBL chassis models

MOUNTING TRAY GENERIC PART NUMBER: CM-TR-3U /CT

/FP Front Panel Layout

CMP: Standard CM front panel fitted with MIL-DTL-38999 connectors *UDP*: User-defined front panel layout (requires customer drawing)

/TC Chassis Top Cover

STC: Standard Top Cover. Wiring clearance 13mm
FTC: Standard Top Cover. Wiring clearance 13mm. (Std. on SEF-18HP)
HTC: High profile Top Cover. Wiring clearance 35mm
HETC: Heat Exchanger Top Cover. Wiring clearance 13mm (Std. on HES & HES-FBL)

/BC Chassis Bottom Cover

SBC: Standard Bottom Cover. Wiring clearance below backplane 25mm HBC: High profile Bottom Cover. Wiring clearance below backplane 40mm

/CS Chassis Card-Cage Slot

MCS: Mixed Card-cage Slots (mixed conduction-cooled & air-cooled boards) CCS: Conduction-cooled Card-cage Slots (conduction-cooled boards only) - MCS is not available for CM-ATR-3U/HES-FBL chassis models

/F Rear-Mounted Fan Assembly

STDF: 2x60 CFM DC Rugged fans (HES, HES-FBL & HES-FBL-HP) <u>or</u> 1x60 CFM DC Rugged fan (FAC)

F115-400: 2x65 CFM 115 VAC @ 400Hz Rotron PX2 Military fans (HES-FBL, HES & HES-FBL-HP) <u>or</u> 1x65 CFM Rotron PX2 Military fan (FAC)

F200-400: 2x120 CFM 200 VAC 3PH @ 400Hz Rotron PX2 fans (HES-FBL, HES & HES-FBL-HP) or 1x120 CFM Rotron PX2 Military fan (FAC)

- No rear fan required for CM-ATR-3U/S & /SEF-HP, omit option from part number.

- Rugged fans are fitted with aluminum housing. Operating range: -10°C to +70°C
- Full military Rotron PX2 AC fans. Operating range: -54°C to +125°C

/C Chassis Color

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B: Black, G: Navy Grey, E: Army Dark Earth, W: White, R: Red, PT: Platinum, YW: Yellow, GN: Green, BLU: Dark Blue, CR: Chromate MIL-C-5541 or O: Other

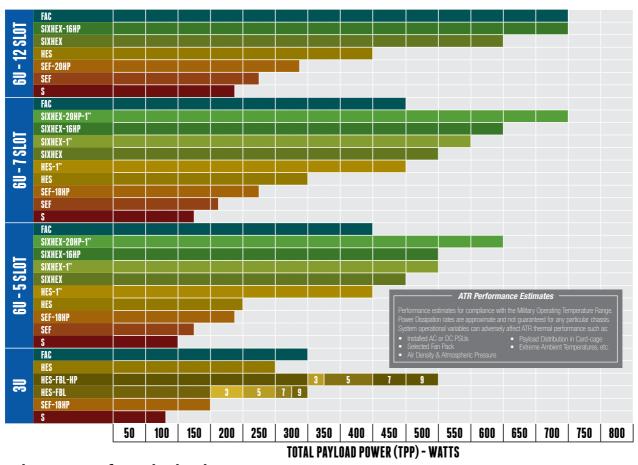
PART NUMBER EXAMPLE: CM-ATR-3U/SEF-18HP/VPX/28VDC/A-475W/UDP/FTC/SBC/CCS/E

- 5 slot, Sealed with Extended Fins + 18 Heat Pipes 3U Avionics Enclosure.
- 5 slot, 3U VPX 1" Pitch backplane. 28VDC input power supply.
 - A-475W power supply (+5 VDC @ 40A, +3.3 VDC @ 22A, ±12 VDC @ 8A)
- User-defined front panel layout (requires drawing).
- Finned Top Cover (\$13mm). Standard Bottom Cover (backplane \$25mm).
- Conduction-cooled Card-cage Slots (conduction-cooled boards only).
- Enclosure color: Army Dark Earth.



CM ATR Chassis Selection Chart

based on system total payload power dissipation



Glossary of Technical Terms establishing new chassis engineering terminology

LT	:	Chassis Linear Thermal Test (Linear Test)	CHMPF :	Chassis Half MTBF Power Factor
PT	:	Chassis Peak Slot Thermal Test (Peak Test)	CPMDC :	Chassis Payload MTBF Degradation Coefficient
MT	:	Chassis Mixed Linear & Peak Slot Thermal Test (Mixed Test)	CIA :	Chassis Installed Airflow
lt-av	:	Linear Test Payload Average Temperature	CEA :	Chassis Effective Airflow
PT-AV	:	Peak Test Payload Average Temperature	ADDT :	Ambient Airflow Delta-T
MT-T1	:	Mixed Test Slot 1 Payload Temperature	CSAOP :	Chassis Stable Airflow Operating Point
MT-AV	:	Mixed Test Payload Average Temperature (excluding Slot 1)	CIARC :	Chassis Impedance Airflow Reduction Coefficient
ΔT	:	Chassis Payload Delta-T with respect to Ambient Temperature	MFARC :	Multiple Fan Airflow Reduction Coefficient
TPP	:	Total Payload Power	OARC :	Overall Airflow Reduction Coefficient
TCEP	:	Total Chassis Electrical Power	SCIDPC :	Sealed Chassis Indirect Delta-T Power Coefficient
CPTR	:	Chassis Payload Thermal Resistance	PEADT :	Payload to Exhaust Airflow Delta-T
CGTR	:	Chassis Global Thermal Resistance	CCAAT :	Chassis Cooling Airflow Average Temperature